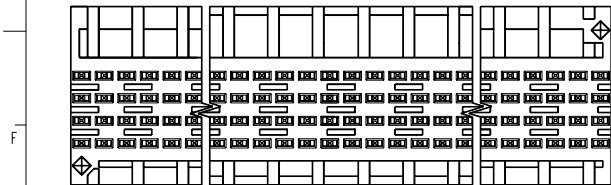
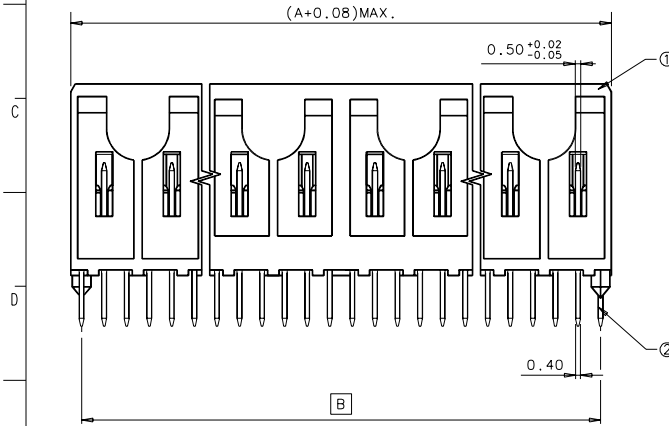
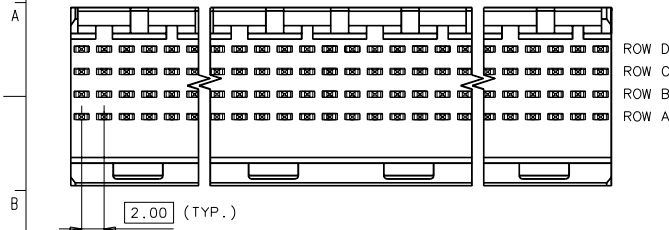
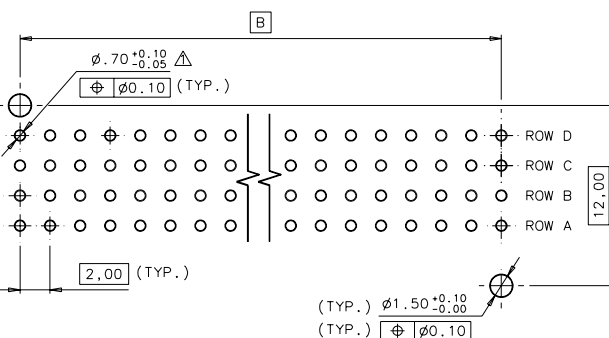
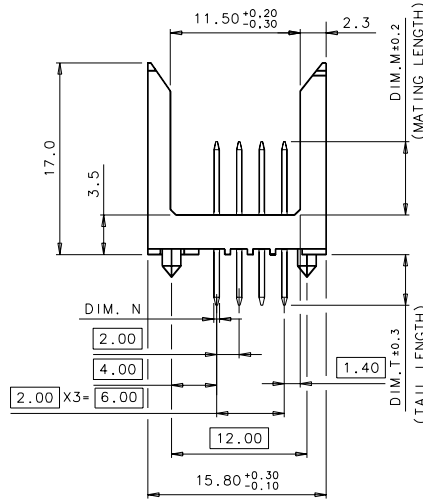


IDEAS GENERATE DRAWING, DON'T CHANGE BY HAND.

REV.	ECN. NO.	APPD.
A	BC05739947	JOHN CHOW
B	BC06708292	JOHN CHOW
C	BC06756904	JOHN CHOW



POS. NO.	DIM. A	DIM. B
192	95.90	94.00
120	59.90	58.00
96	47.90	46.00
72	35.90	34.00
48	23.90	22.00
24	11.90	10.00



RECOMMENDED PCB LAYOUT
(COMPONENT SIDE)

NOTES: UNLESS OTHERWISE SPECIFIED.

△ SOLDER HOLES:

- HOLE DIAMETER AFTER PLATING: 0.65~0.80mm.
- DRILLED HOLE: 0.81~0.86mm.
- COPPER PLATING: 0.025mm MIN.
- TIN-LEAD OR LEAD FREE PLATING: 0.005~0.015mm.

2. ELECTRICAL CHARACTERISTICS:

- CURRENT RATING: 1A MAX. PER CONTACT WITH ALL CONTACTS ENERGIZED.
- DIELECTRIC WITHSTANDING VOLTAGE: 1000 V A.C.

3. MECHANICAL CHARACTERISTICS:

- CURRENT RATING: 1A MAX. PER CONTACT WITH ALL CONTACTS ENERGIZED.
- DIELECTRIC WITHSTANDING VOLTAGE: 1000 V A.C.

4. DESIGNED TO CONFORM WITH IEC 61076-4-104.

PART LIST

POS. NO.	DESCRIPTION	MATERIAL	TREATMENT
024	24POS.		
048	48POS.		
072	72POS.		
096	96POS.		
120	120POS.		
192	192POS.		
PLATING SPEC.			
1	GOLD FLASH		
3	0.76um(30u*)MIN. GOLD PLATING		
5	1.27um(50u*)MIN. GOLD PLATING		
6	0.25um(10u*)MIN. GOLD PLATING		
A	0.76um(30u*)MIN. FPT PLATING		
B	0.25um(10u*)MIN. GOLD INCLUDED.		
B	0.76um(30u*)MIN. FPT PLATING		
C	0.25um(10u*)MIN. GOLD INCLUDED.		
C	1.27um(50u*)MIN. FPT PLATING		
D	0.50um(20u*)MIN. GOLD INCLUDED.		
D	1.27um(50u*)MIN. FPT PLATING		
D	0.25um(10u*)MIN. GOLD INCLUDED.		
TAIL STYLE			
S	SOLDER TAIL		
LEAD FREE CODE			
N	NONE		
F	LEAD FREE PLATING		
PACKAGE TYPE			
A	TUBE		
EXTENSION CODE			
N,T,L,M,A,B,C,D			
BODY STYLE			
MATING LENGTH(DIM.M)			
1	5.00 mm		
2	5.75 mm		
3	6.50 mm		
4	7.25 mm		
5	8.00 mm		
TAIL LENGTH(DIM.T)			
1	2.9 mm (DIM.N=0.50)		
2	3.7 mm (DIM.N=0.50)		
3	4.5 mm (DIM.N=0.50)		
4	2.65 mm (DIM.N=0.50)		
5	3.45 mm (DIM.N=0.50)		
6	4.25 mm (DIM.N=0.40)		
7	2.73 mm (DIM.N=0.40)		
8	2.65 mm (DIM.N=0.40)		
9	3.45 mm (DIM.N=0.40)		

ITEM	DESCRIPTION	MATERIAL	TREATMENT
2	CONTACT	PHOSPHOR BRONZE	1) 2.54um(100u*)MIN. NICKEL UNDERPLATING. 2) 3.81um(150u*)MIN. TIN LEAD OR LEAD FREE PLATING ON SOLDER AREA. 3) PLATING SPEC. OF MATING AREA, DETAIL REFER TO PART LIST.
1	HOUSING	LCP	IVORY WHITE, UL 94V-0
TREATMENT			
X. ±	X. ±	UNITS mm	NAME (INTENDED USE)
.X ± 0.20	.X ±	MAT'L	FUTURE BUS HEADER CONNECTOR
.XX ± 0.10	.XX ±		PART NO. (INTENDED USE)
.XXX ±	.XXX ±	FINISH	1F11****-S**40*--**
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF HON HAI PRECISION IND. CO., LTD. AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF HON HAI PRECISION IND. CO., LTD.			TITLE: CUSTOMER DRAWING SIGNAL MODULE, 4 ROW WIDE TYPE, SOLDER TYPE
Q'TY			APPD: JOHN CHOW 9/22'06
			CHKD: CAMVARD 9/21'06
			DR: ARES HUANG 9/20'06
			DWG NO.: 343-0000-1101
			SCALE SHEET REV.
			N/A 1/1 C